

Title (en)
SYSTEM FOR ASSEMBLING SUBSTRATES TO BONDING ZONES PROVIDED WITH CAVITIES

Title (de)
MONTAGEMETHODE VON SUBSTRATEN MIT HALTEBEREICHEN MIT KAVITÄTEN

Title (fr)
SYSTEME D'ASSEMBLAGE DE SUBSTRATS A ZONES D'ACCROCHAGE POURVUES DE CAVITES

Publication
EP 1129479 A1 20010905 (FR)

Application
EP 99950858 A 19991028

Priority
• FR 9902626 W 19991028
• FR 9813583 A 19981029

Abstract (en)
[origin: FR2785449A1] The invention concerns a device comprising a first substrate (100) with at least a bonding zone (110a, 110b), capable of being assembled with a second substrate (200), the bonding zone (110a, 110b) having a surface made of material (104) capable of being wetted by a fusible material. The invention is characterised in that the bonding zone (110a, 110b) is provided with at least one cavity (20) for receiving the fusible material.

IPC 1-7
H01L 21/50; H01L 23/10; H01L 23/66; H01L 23/552; B81B 7/00

IPC 8 full level
B81B 7/00 (2006.01); **B81C 1/00** (2006.01); **H01L 21/50** (2006.01); **H01L 23/10** (2006.01); **H01L 23/552** (2006.01); **H01L 23/66** (2006.01)

CPC (source: EP US)
B81B 7/0064 (2013.01 - EP US); **B81C 1/00269** (2013.01 - EP US); **H01L 21/50** (2013.01 - EP US); **H01L 23/10** (2013.01 - EP US); **H01L 23/552** (2013.01 - EP US); **H01L 23/66** (2013.01 - EP US); **B81C 2203/019** (2013.01 - EP US); **H01L 2924/1617** (2013.01 - EP US); **Y10T 428/12347** (2015.01 - EP US); **Y10T 428/12396** (2015.01 - EP US); **Y10T 428/12528** (2015.01 - EP US)

Citation (search report)
See references of WO 0026958A1

Designated contracting state (EPC)
DE GB IT

DOCDB simple family (publication)
FR 2785449 A1 20000505; **FR 2785449 B1 20021129**; EP 1129479 A1 20010905; US 6531232 B1 20030311; WO 0026958 A1 20000511

DOCDB simple family (application)
FR 9813583 A 19981029; EP 99950858 A 19991028; FR 9902626 W 19991028; US 80768801 A 20010416